

IN THE CLAIMS:

Sub B1
1. (Currently Amended) A fault detecting method for a semiconductor integrated circuit, ~~characterized in that:~~
comprising:

A2
providing a fault list corresponding to (a) information on identifying physical sites of a semiconductor integrated circuit where a possible fault is likely to occur or (b) information required to reduce faults; and ~~is used to perform detection for~~
detecting faults in said a semiconductor integrated circuit to which said fault list corresponds by using said fault list.

2. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 1, wherein ~~in fault detection, faults that are difficult to detect are omitted from the fault list before detection is performed for faults in the semiconductor integrated circuit using a remaining part of the fault list~~additionally comprising:

omitting possible faults that are difficult to detect from the fault list to define a remaining part of the fault list, and

Serial No.: 09/697,305

SW
BL

detecting faults in said semiconductor integrated circuit
by using the remaining part of the fault list.

3. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 1, wherein the fault list ~~contains~~ comprises data on about a likelihood of each a fault occurring at a site.

AD

4. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 3, wherein ~~detection is performed for faults in the semiconductor integrated circuit using a fault list ordered with the likelihood of each fault~~ additionally comprising:

ordering the possible faults in the fault list according to
their likelihood of occurrence to create an ordered fault list,
and
detecting faults in said semiconductor integrated circuit
by using the ordered fault list.

Sw
B1

5. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 3, wherein the additionally comprising weighting possible faults are weighted with at sites according to their likelihood to determine achieve a specific fault coverage, thereby creating weighted possible faults, said fault coverage being a probability of detecting faults in said semiconductor integrated circuit, detecting faults using a fault list comprising said weighted possible faults for a fault detection.

A2

6. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 5, additionally comprising ordering possible wherein the faults before weighting possible faults are ordered with their likelihood and are weighted in accordance with this ordering.

7. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 4, additionally comprising obtaining mask information from a layout device for laying out the semiconductor integrated circuit to

Serial No.: 09/697,305

Sub B1
which the fault list corresponds, wherein faults are ordered or weighted with their likelihood

said ordering possible faults is based on the mask information obtained from a layout device for laying out the semiconductor integrated circuit.

8. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 4, wherein further comprising:

AB
calculating a density of a mask pattern is calculated based on corresponding to mask information obtained from the a layout device for laying out the semiconductor integrated circuit to which said fault list corresponds;

calculating a likelihood of occurrence of possible faults depending on the density of the mask pattern; and

ordering or weighting the possible faults according to their likelihoods of occurrence~~are ordered or weighted with their likelihood depending on the density of the mask pattern.~~

Sub B1

9. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 4, wherein ~~additionally comprising: the faults are ordered or weighted with their likelihood using~~ providing a database for storing therein reliability data based on records of past use of cells or functional blocks of the semiconductor integrated circuit to which the fault list corresponds; and ordering the possible faults according to their likelihoods of occurrence, using the database.

A2

10. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 6, wherein ~~a fault coverage that can be obtained when detecting each fault is calculated and faults that are not required to achieve a specified fault coverage are deleted in the order of the unlikelihood of the faults, and detecting process is conducted for the remaining faults~~ additionally comprising: defining a required fault list by deleting from the fault list possible faults that are not required to achieve a

Serial No.: 09/697,305

Sub B1

specified fault coverage, in an order of unlikelihood of such possible faults, said specific fault coverage being a probability of detecting faults in the semiconductor integrated circuit to which said fault list corresponds; and
detecting, using said required fault list, remaining faults in said semiconductor integrated circuit; and
calculating a fault coverage simultaneously with said detecting.

A2

11. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 6, wherein additionally comprising:

calculating the fault coverage is calculated while carrying out a process for simultaneously with detecting possible faults in said semiconductor integrated circuit; and each fault detection in accordance with the ordering, and the process is stopped

terminating calculating and detecting the when a specific specified fault coverage has been reached, said specific fault

Serial No.: 09/697,305

Sub B1
coverage being a probability of detecting faults in said semiconductor integrated circuit.

12. (Currently Amended) A fault detecting method for a semiconductor integrated circuit, characterized in ~~that~~ comprising:

AD
~~detection is performed for first detecting faults in a semiconductor integrated circuit to create a fault list~~ detection result; corresponding to

combining said detection result with (a) information on about physical sites of in the semiconductor integrated circuit to which said fault list corresponds where a possible fault is likely to occur or (b) information required to reduce faults, to create a fault list; and so that this fault list can be used to perform detection for

using said fault list for second detecting faults in said semiconductor integrated circuit.

Serial No.: 09/697,305

Sub
BL

13. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 12, wherein ~~in fault detection, faults that are difficult to detect are omitted from a fault list before detection is performed for faults in the semiconductor integrated circuit using a remaining part of the fault list~~ additionally comprising:

a2

omitting from the fault list possible faults that are difficult to detect to define a remaining part of the fault list, wherein

said second detecting faults in a semiconductor integrated circuit to which said fault list comprises using the remaining part to detect faults.

14. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 12, wherein ~~the fault list contains~~ comprises data on ~~about a~~ likelihood of each a possible fault occurring at a site.

Sub B1
15. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 14, wherein ~~detection is performed for faults in the semiconductor integrated circuit using a fault list ordered with the likelihood of each fault~~additionally comprising:

ordering the possible faults according to their likelihood of occurrence to create an ordered fault list, and

12
second detecting possible faults in said semiconductor integrated circuit using the ordered fault.

16. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 14, ~~wherein the~~ additionally comprising weighting possible faults are weighted with at sites according to their likelihood to determine achieve a specific fault coverage, thereby creating weighted possible faults, said fault coverage being a probability of detecting faults in said semiconductor integrated circuit, and for a fault detection

second detecting faults using a fault list comprising said weighted possible faults.

Sub B1

17. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 16, wherein the additionally comprising ordering possible faults before weighting possible faults ~~are ordered with their likelihood and are weighted in accordance with this ordering.~~

Q2

18. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 15, additionally comprising obtaining mask information from a layout device for laying out the semiconductor integrated circuit to which the fault list corresponds, ~~wherein the faults are ordered or weighted with their likelihood~~

said ordering possible faults is based on the mask information obtained from a layout device for laying out the semiconductor integrated circuit.

19. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 15, wherein further comprising

Serial No.: 09/697,305

Sub
B1

~~_____ calculating a density of a mask pattern is calculated based
on corresponding to mask information obtained from the a layout
device for laying out the semiconductor integrated circuit to
which said fault list corresponds_T; and the faults are ordered
or weighted with~~

~~_____ calculating a likelihood of occurrence of possible faults
depending on the density of the mask pattern; and~~

A2

~~_____ ordering or weighting the possible faults according to
their likelihood likelihoods of occurrence depending on the
density of the mask pattern.~~

20. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 15, wherein further comprising: ~~the faults are ordered or weighted with their likelihood using~~

~~_____ providing a database for and storing therein reliability data based on records of past use of cells or functional blocks of the semiconductor integrated circuit to which the fault list corresponds; and~~

Serial No.: 09/697,305

Sub B1
ordering the possible faults according to their likelihoods of occurrence, using the database.

A2
21. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 17, wherein ~~a fault coverage that can be obtained when detecting each fault is calculated and faults that are not required to achieve a specified fault coverage are deleted in the order of the unlikelihood of the faults, and detecting process is conducted for the remaining faults additionally comprising:~~

defining a required fault list by deleting from the fault list possible faults that are not required to achieve a specified fault coverage in an order of unlikelihood of such possible faults, said specific fault coverage being a probability of detecting faults in the semiconductor integrated circuit to which said fault list corresponds; and

second detecting using said required fault list, remaining possible faults in said semiconductor integrated circuit; and

calculating a fault coverage simultaneously with said second detecting.

Sub B1

22. (Currently Amended) The fault detecting method for a semiconductor integrated circuit according to claim 17, additionally comprising: wherein the
calculating the fault coverage simultaneously with
detecting possible faults in said semiconductor integrated
circuit; and
terminating calculating and detecting is calculated while
carrying out a process for each fault detection in accordance
with the ordering, and the process is stopped once the when a
specific specified fault coverage has been reached, said
specific fault coverage being a probability of detecting faults
in said semiconductor integrated circuit.

A2

23. (Withdrawn) A layout method for a semiconductor integrated circuit, characterized in that:

a fault list corresponding to information on sites of a semiconductor integrated circuit where a fault is likely to occur or information required to reduce faults is used to

Serial No.: 09/697,305

Sub B1
perform mask layout and wiring for said semiconductor integrated circuit.

24. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 23, wherein the fault list contains data on likelihood of each fault.

A2
25. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 24, wherein the mask layout and the wiring are performed for the semiconductor integrated circuit using a fault list ordered with the likelihood of each fault.

26. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 24, wherein the faults are weighted with their likelihood to determine a fault coverage for the mask layout and wiring for the semiconductor integrated circuit.

Serial No.: 09/697,305

Sub
B1

27. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 26, wherein the faults are ordered with their likelihood and are weighted in accordance with this ordering.

a2

28. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 25, wherein the faults are ordered or weighted with their likelihood based on mask information obtained from a layout device for laying out the semiconductor integrated circuit.

29. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 25, wherein a density of a mask pattern is calculated based on mask information obtained from the layout device for laying out the semiconductor integrated circuit, and the faults are ordered or weighted with their likelihood depending on the density of the mask pattern.

Sub B1 30. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 25, wherein the faults are ordered or weighted with their likelihood using a database for reliability based on records of past use of cells or functional blocks of the semiconductor integrated circuit.

A2 31. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 27, wherein a fault coverage that can be obtained when detecting each fault is calculated, faults that are not required to achieve a specified fault coverage are deleted in the order of the unlikelihood of the faults, and detecting process is conducted for the remaining faults.

32. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 27, wherein the fault coverage is calculated while carrying out a process for each fault detection in accordance with the ordering, and the process is stopped once the specified fault coverage has been reached.

Sub B1 33. (Withdrawn) A layout method for a semiconductor integrated circuit, characterized in that:

detection is performed for faults in a semiconductor integrated circuit to create a fault list indicating information on sites of a semiconductor where a fault is likely to occur or information required to reduce faults so that this fault list can be used to perform mask layout and wiring for said semiconductor integrated circuit.

a2 34. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 33, wherein the fault list contains data on likelihood of each fault.

35. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 34, wherein the mask layout and the wiring are performed for the semiconductor integrated circuit using a fault list ordered with the likelihood of each fault.

Sub B1
36. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 34, wherein the faults are weighted with their likelihood to determine a fault coverage for the mask layout and wiring for the semiconductor integrated circuit.

37. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 36, wherein the faults are ordered with their likelihood and are weighted in accordance with this ordering.

38. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 35, wherein the faults are ordered or weighted with their likelihood based on mask information obtained from a layout device for laying out the semiconductor integrated circuit.

39. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 35, wherein a density of a mask pattern is calculated based on mask information obtained

Serial No.: 09/697,305

Sub
B1

from the layout device for laying out the semiconductor integrated circuit, and the faults are ordered or weighted with their likelihood depending on the density of the mask pattern.

40. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 35, wherein the faults are ordered or weighted with their likelihood using a database for reliability based on records of past use of cells or functional blocks of the semiconductor integrated circuit.

A2

41. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 37, wherein a fault coverage that can be obtained when detecting each fault is calculated, faults that are not required to achieve a specified fault coverage are deleted in the order of the unlikelihood of the faults, and detecting process is conducted for the remaining faults.

42. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 37, wherein the fault

Serial No.: 09/697,305

SWR
B1

coverage is calculated while carrying out a process for each fault detection in accordance with the ordering, and the process is stopped once the specified fault coverage has been reached.

43. (Withdrawn) A layout method for a semiconductor integrated circuit, characterized in that:

A2

faults that are difficult to detect are omitted from a fault list before mask layout and wiring are performed based on the remaining part of the fault list for the semiconductor integrated circuit.

44. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 43, wherein the fault list contains data on likelihood of each fault.

45. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 44, wherein the mask layout and the wiring are performed for the semiconductor integrated circuit using a fault list ordered with the likelihood of each fault.

Sub B1
46. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 44, wherein the faults are weighted with their likelihood to determine a fault coverage for the mask layout and wiring for the semiconductor integrated circuit.

A2
47. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 46, wherein the faults are ordered with their likelihood and are weighted in accordance with this ordering.

48. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 45, wherein the faults are ordered or weighted with their likelihood based on mask information obtained from a layout device for laying out the semiconductor integrated circuit.

49. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 45, wherein a density of a

Serial No.: 09/697,305

Sub B1 mask pattern is calculated based on mask information obtained from the layout device for laying out the semiconductor integrated circuit, and the faults are ordered or weighted with their likelihood depending on the density of the mask pattern.

50. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 45, wherein the faults are ordered or weighted with their likelihood using a database for reliability based on records of past use of cells or functional blocks of the semiconductor integrated circuit.

51. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 47, wherein a fault coverage that can be obtained when detecting each fault is calculated, faults that are not required to achieve a specified fault coverage are deleted in the order of the unlikelihood of the faults, and detecting process is conducted for the remaining faults.

Serial No.: 09/697,305

Sub B1
A2

52. (Withdrawn) The layout method for a semiconductor integrated circuit according to claim 47, wherein the fault coverage is calculated while carrying out a process for each fault detection in accordance with the ordering, and the process is stopped once the specified fault coverage has been reached.
